

# FILE COPY

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of: Norio FUKASAWA, et al.

Serial Number: 09/029,608

Group Art Unit: 2814

Filed: May 15, 1998

Attention: Appln Processing Division,  
Customer Correction Branch

For: METHOD AND MOLD FOR MANUFACTURING SEMICONDUCTOR DEVICE,  
SEMICONDUCTOR DEVICE, AND METHOD FOR MOUNTING THE DEVICE

### REQUEST FOR CORRECTED FILING RECEIPT

Assistant Commissioner for Patents  
Washington, D.C. 20231

Date: September 8, 1999

Sir:

Please supply the undersigned attorney with a corrected filing receipt for the above-identified application. The undersigned also respectfully requests that the Patent and Trademark Office records be amended to reflect the correction.

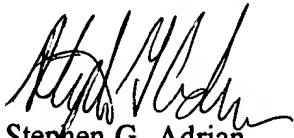
In reviewing the official Filing Receipt, we noted an error in that the filing date of the PCT International Application is incorrect ("10/07/97" should be - -07/10/97- -). A copy of the Declaration is enclosed which indicates the correct date.

We are enclosing a copy of the filing receipt with the corrections highlighted.

In the event that any fees are required in connection with this paper, please charge our Deposit Account No. 01-2340.

Respectfully submitted,

ARMSTRONG, WESTERMAN, HATTORI,  
MCLELAND & NAUGHTON

  
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Enclosures: Copies of Filing Receipt & Declaration

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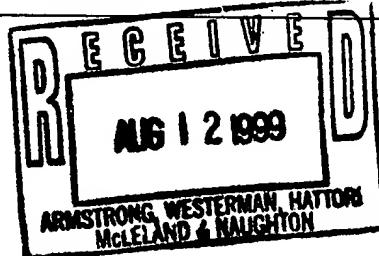
FILING RECEIPT



UNITED STATES DEPARTMENT OF COMMERCE  
Patent and Trademark Office  
ASSISTANT SECRETARY AND COMMISSIONER  
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APPLICATION NUMBER	FILING DATE	GRP ART UNIT	FIL FEE REC'D	ATTORNEY DOCKET NO.	DRWGS	TOT CL	IND CL
09/029,608	05/15/98	2814	\$5,014.00	980233	131	86	16

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Receipt is acknowledged of this nonprovisional Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please write to the Office of Initial Patent Examination's Customer Service Center. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts of Application" ("Missing Parts Notice") in this application, please submit any corrections to this Filing Receipt with your reply to the "Missing Parts Notice." When the PTO processes the reply to the "Missing Parts Notice," the PTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

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CONTINUING DATA AS CLAIMED BY APPLICANT-  
THIS APPLN IS A 371 OF PCT/JP97/02405

07/10/97

10/07/97

## FOREIGN APPLICATIONS-

JAPAN	8-183844	07/12/96
JAPAN	8-276634	10/18/96
JAPAN	9-010683	01/23/97
JAPAN	9-181132	07/07/97

IF REQUIRED, FOREIGN FILING LICENSE GRANTED 07/29/99

## TITLE

METHOD AND MOLD FOR MANUFACTURING SEMICONDUCTOR DEVICE, SEMICONDUCTOR DEVICE, AND METHOD FOR MOUNTING THE DEVICE

PRELIMINARY CLASS: 438

DATA ENTRY BY: JOY DOZIER

TEAM: 13 DATE: 07/29/99



(See reverse for new important information)

## Declaration and Power of Attorney for U.S. Patent Application

### 特許出願宣言書及び委任状

### Japanese Language Declaration

### 日本語宣言書

下記の氏名の発明者として、私は以下通り宣言します。 As a below named inventor, I hereby declare that:

私の住所、私書箱、国籍は下記の私の氏名の後に記載された通りです。

下記の名称の発明に関して請求範囲に記載され、特許出願している発明内容について、私が最初かつ唯一の発明者（下記の氏名が一つの場合）もしくは最初かつ共同発明者であると（下記の名称が複数の場合）信じています。

My residence, post office address and citizenship are as stated next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

METHOD AND MOLD FOR MANUFACTURING  
SEMICONDUCTOR DEVICE, SEMICONDUCTOR  
DEVICE, AND METHOD FOR MOUNTING THE  
DEVICE

上記発明の明細書（下記の欄でx印がついていない場合は、本書に添付）は、

一月一日に提出され、米国出願番号または特許協定条約国際出願番号を \_\_\_\_\_ とし。  
(該当する場合) \_\_\_\_\_ に訂正されました。

the specification of which is attached hereto unless the following box is checked:

was filed on July 10, 1997  
as United States Application Number or  
PCT International Application Number PCT/JP97/02405  
and was amended on \_\_\_\_\_  
(if applicable).

私は、特許請求範囲を含む上記訂正後の明細書を検討し、内容を理解していることをここに表明します。

私は、連邦規則法典第37編第1条56項に定義されるとおり、特許資格の有無について重要な情報を開示する義務があることを認めます。

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, Section 1.56.